TE Internal #: 2170680-1

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, EMI

Springs, SFP+, 1 x 1, Through Hole - Press-Fit Mount, 1 Port, Cable-

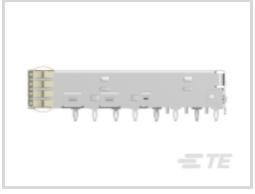
to-Board, Sealable

View on TE.com >



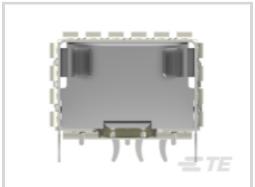
Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+











Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 16 Gb/s

EMI Containment Feature Type: EMI Springs

Pluggable I/O Applications: **SFP+**

Included Lightpipe: No

Features

Product Type Features

Form Factor	SFP+
Cage Type	Single
Pluggable I/O Product Type	Cage Assembly
Connector System	Cable-to-Board
Sealable	Yes
Connector & Contact Terminates To	Printed Circuit Board
Configuration Footures	

Configuration Features

Port Matrix Configuration	1 × 1
Number of Ports	1

Electrical Characteristics

Data Rate (Max) 16 Gb/s

Termination Features

Mechanical Attachment



PCB Mounting Style	Through Hole - Press-Fit
Connector Mounting Type	Board Mount
Housing Features	
Cage Material	Nickel Silver Alloy
Dimensions	
Tail Length	3 mm
PCB Thickness (Recommended)	1.5 mm[.059 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Heat Sink Compatible	No
For Use With Pluggable I/O Products	SFP+ SMT Connector
Pluggable I/O Applications	SFP+
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tray
Other	
EMI Containment Feature Type	EMI Springs
	No

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per



homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



30 AWG



26 AWG

























Customers Also Bought















TE Part #2350231-7 SFP28 STACKED 2X1 RECEPTACLE **ASSEMBLY**



Documents

Product Drawings

SFP+ 1x1 Cage Assembly, Press-

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2170680-1_A.2d_dxf.zip



English

Customer View Model

ENG_CVM_CVM_2170680-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2170680-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Product Environmental Compliance

MD_2170680-1_050920181211_dmtec

English

MD_2170680-1_050920181211_dmtec

English